

Electronic Patent Application Fee Transmittal

Application Number:	10607782			
Filing Date:	27-Jun-2003			
Title of Invention:	Liquid solder thermal interface material contained within a cold-formed barrier and methods of making same			
First Named Inventor/Applicant Name:	Sabina J. Houle			
Filer:	Joseph P. Mehrle/Anne Richards			
Attorney Docket Number:	884.860US1			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				790